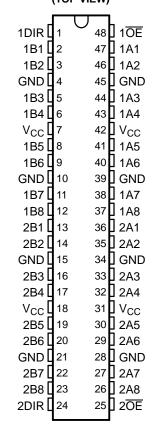
SN54ABT16245A, SN74ABT16245A 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS300F-MARCH 1994-REVISED JULY 2005

FEATURES

- Members of the Texas Instruments Widebus™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- Typical V_{OLP} (Output Ground Bounce) <1 V at V_{CC} = 5 V, T_A = 25°C
- High-Impedance State During Power Up and Power Down
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (–32-mA I_{OH}, 64-mA I_{OL})
- Latch-Up Performance Exceeds 500 mA Per JESD 70
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Includes Plastic Thin Very Small-Outline (DGV), Shrink Small-Outline (DL), and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic (WD) Flat Package Using 25-mil Center-to-Center Spacings

SN54ABT16245A... WD PACKAGE SN74ABT16245A... DGG, DGV, OR DL PACKAGE (TOP VIEW)



DESCRIPTION

The 'ABT16245A devices are 16-bit noninverting 3-state transceivers designed for synchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

These devices can be used as two 8-bit transceviers or one 16-bit transceiver. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so that the buses are effectively isolated.

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impendance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16245A is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ABT16245A is characterized for operation from -40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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FUNCTION TABLE (EACH 8-BIT SECTION)

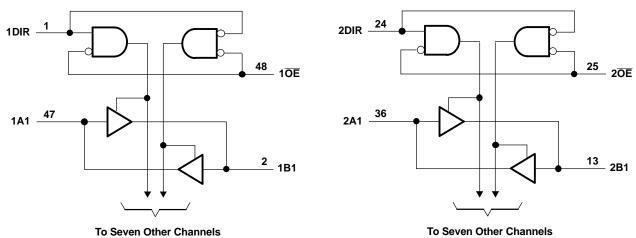
INP	UTS	OPERATION
OE	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
Н	Χ	Isolation

LOGIC SYMBOL⁽¹⁾ 48 10E G3 1 1DIR 3 EN1 [BA] 3 EN2 [AB] 25 G6 20E 24 2DIR 6 EN4 [BA] 6 EN5 [AB] 47 2 1B1 **▽ 1** \triangleleft \triangleright 2 ▽ 46 3 1B2 1A2 44 5 1A3 1B3 43 6 1A4 1B4 41 8 1A5 1B5 40 9 1A6 1B6 38 11 1A7 1B7 37 12 1A8 1B8 36 ∇ 4 2B1 2A1 \triangleleft \triangleright 5 ▽ 35 14 2B2 2A2 33 16 2A3 2B3 32 17 2A4 2B4 30 19 2B5 2A5 29 20 2B6 2A6 27 22 2A7 2B7 26 23 2A8 2B8

(1) This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



LOGIC DIAGRAM (POSITIVE LOGIC)



Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{CC}	Supply voltage range	-0.5	7	٧	
VI	Input voltage range (except I/O ports)(2)	-0.5	7	V	
Vo	Voltage range applied to any output in the high or power-off state				V
Io	Compart into any system tip the law state	SN54ABT16245A		96	A
	Current into any output in the low state	SN74ABT16245A		128	mA
I _{IK}	Input clamp current	V _I < 0		-18	mA
I _{OK}	Output clamp current	V _O < 0		-50	mA
		DGG package		89	
θ_{JA}	Package thermal impedance (3)	DGV package		93	°C/W
		DL package		94	
T _{stg}	Storage temperature range				°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability

⁽²⁾ The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

⁽³⁾ The package thermal impedance is calculated in accordance with JESD 51.

SN54ABT16245A, SN74ABT16245A 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

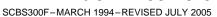




Recommended Operating Conditions⁽¹⁾

			SN54ABT	16245A	SN74ABT	16245A	LINUT
			MIN	MAX	MIN	MAX	UNIT
V _{CC}	Supply voltage		4.5	5.5	4.5	5.5	V
V_{IH}	High-level input voltage		2		2		V
V_{IL}	Low-level input voltage		0.8		0.8	V	
V_{I}	Input voltage		0	V_{CC}	0	V_{CC}	V
I _{OH}	High-level output current			-24		-32	mA
I _{OL}	Low-level output current			48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
$\Delta t/\Delta V_{CC}$	Power-up ramp rate		200		200		μs/V
T_A	Operating free-air temperature		-55	125	-40	85	°C

⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.





Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER V _{IK}		TEST CONDITIONS			T _A = 25°C		SN54ABT16245A		SN74ABT16245A		UNIT
					MIN TYP ⁽¹⁾ MAX		MIN MAX		X MIN MAX		UNII
		V _{CC} = 4.5 V,	I _I = −18 mA			-1.2	8	-1.2		-1.2	V
		V _{CC} = 4.5 V,	$I_{OH} = -3 \text{ mA}$	2.5			2.5		2.5		
		$V_{CC} = 5 \text{ V}, \qquad I_{OH} = -3 \text{ mA}$		3			3		3		,
V_{OH}		V 45V	$I_{OH} = -24 \text{ mA}$	2			2				V
		V _{CC} = 4.5 V	$I_{OH} = -32 \text{ mA}$	2(2)					2		
.,		V 45V	I _{OL} = 48 mA			0.55		0.55			V
V_{OL}		$V_{CC} = 4.5 \text{ V}$	I _{OL} = 64 mA			0.55(2)				0.55	V
V _{hys}					100						mV
	Control inputs	$V_{CC} = 0 \text{ to } 5.5 \text{ V}, V_{I} = V_{CC}$	√ _{CC} or GND			±1		±1		±1	^
I _I	A or B port	V _{CC} = 2.1 V to 5.5 V, V			±20 ⁽²⁾		±100		±20	μА	
l _{OZPU}		$V_{CC} = 0 \text{ to } 2.1 \text{ V}, V_{O} = 0.5 \text{ V to } 2.7 \text{ V}, \overline{OE} = X$				±50(3)		±50(3)		±50	μΑ
I _{OZPD}		$V_{CC} = 2.1 \text{ V to } 0, V_{O} = 0.5 \text{ V to } 2.7 \text{ V}, \overline{OE} = X$				±50(3)		±50 ⁽³⁾		±50	μΑ
I _{OZH} ⁽⁴⁾		V_{CC} = 2.1 V to 5.5 V, V_{O} = 2.7 V, \overline{OE} \geq 2 V				10 ⁽⁵⁾		10		10 ⁽⁵⁾	μА
I _{OZL} ⁽⁴⁾		V_{CC} = 2.1 V to 5.5 V, V_{O} = 0.5 V, OE \geq 2 V				-10 ⁽⁵⁾		-10		-10 ⁽⁵⁾	μΑ
I _{off}		$V_{CC} = 0$,	V_I or $V_O \le 5.5 \text{ V}$			±100				±100	μΑ
I _{CEX}		V _{CC} = 5.5 V, V _O = 5.5 V	Outputs high			50		50		50	μΑ
I _O ⁽⁶⁾		$V_{CC} = 5.5 \text{ V},$	V _O = 2.5 V	-50	-100	-180	-50	-180	-50	-180	mA
			Outputs high			2		2		2	
I_{CC}	A or B	$V_{CC} = 5.5 \text{ V}, I_{O} = 0, \\ V_{I} = V_{CC} \text{ or GND}$	Outputs low			32		32		32	mA
	port	V1 = VCC 01 0112	Outputs disabled			2		2		2	
	_	$V_{CC} = 5.5 \text{ V},$	Outputs enabled			2		1.5		2	
ΔI _{CC} ⁽⁷⁾	Data inputs	One inputs at 3.4 V, Other inputs at V _{CC} or GND	Outputs disabled			0.05		1		0.05	mA
	Control inputs	V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND				1.5		1.5		1.5	
Ci	Control inputs	V _I = 2.5 V or 0.5 V			3						pF
C _o	A or B port	V _O = 2.5 V or 0.5 V			6						pF

- All typical values are at V_{CC} = 5 V. On products compliant to MIL-PRF-38535, this parameter does not apply. On products compliant to MIL-PRF-38535, this parameter is not production tested.
- The parameters I_{OZH} and I_{OZL} include the input leakage current.
- This limit may vary among suppliers.
- (6) Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
- This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

SN54ABT16245A, SN74ABT16245A 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS300F-MARCH 1994-REVISED JULY 2005



Switching Characteristics

over recommended operating ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

			SN54ABT16245A					
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V ₀	,	MIN	MAX	UNIT	
			MIN	TYP	MAX			
t _{PLH}	A or B	B or A	0.5	2.2	3.4	0.5	4	ns
t _{PHL}	AOIB	BUIA	0.5	2.3	3.8	0.5	4.6	
t _{PZH}	OE	B or A	8.0	3.6	5.2	0.8	5.5	ne
t _{PZL}	OL	BUIA	0.9	3.7	6.1	0.1	7.3	ns
t _{PHZ}	OE	B or A	1.3	4.4	5.8	1.3	6.3	20
t _{PLZ}	OL	BUIA	1.4	3.3	4.7	1.4	5.5	ns

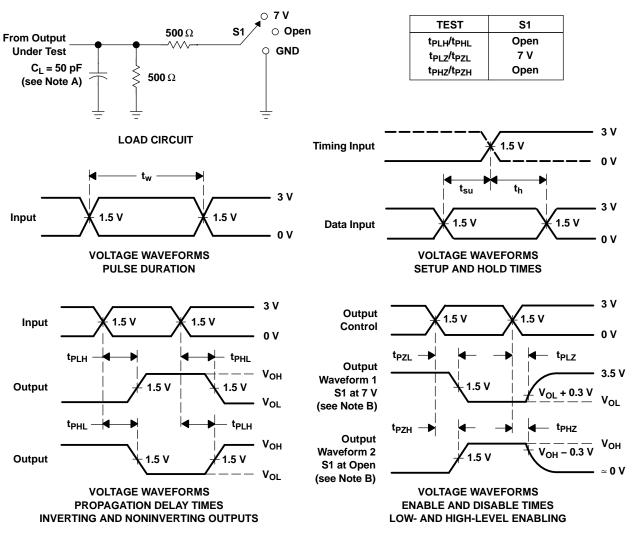
Switching Characteristics

over recommended operating ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _C	,	MIN	MAX	UNIT	
			MIN	TYP	MAX			
t _{PLH}	A or B	B or A	1	2.2	3.4	1	3.9	
t _{PHL}	AUB	BULA	1	2.3	3.7	1	4.2	ns
t _{PZH}	- OE	B or A	1	3.6	5.2	1	6.3	ns
t _{PZL}	OL	BULK	1	3.7	5.4	1	6.4	115
t _{PHZ}	- OE	B or A	2	4.4	5.8	2	6.3	ns
t _{PLZ}	OL	BULA	1.5	3.3	4.7	1.5	5.2	115



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f \leq 2.5$ ns. $t_f \leq 2.5$ ns.
- D. The outputs are measured one at a time, with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





.com 26-Sep-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-9317501MXA	ACTIVE	CFP	WD	48	1	TBD	Call TI	Level-NC-NC-NC
74ABT16245ADGGRG4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ABT16245ADGVRE4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16245ADGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16245ADGVR	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16245ADL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16245ADLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16245ADLRG4	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54ABT16245AWD	ACTIVE	CFP	WD	48	1	TBD	Call TI	Level-NC-NC-NC

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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WD (R-GDFP-F**)

CERAMIC DUAL FLATPACK

48 LEADS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only
- E. Falls within MIL STD 1835: GDFP1-F48 and JEDEC MO-146AA

GDFP1-F56 and JEDEC MO-146AB

DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

DL (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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